

#### **Description**

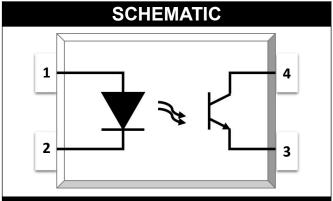
The TD851 series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a silicon planar high voltage phototransistor detector in a plastic DIP4 package with different lead forming options. With the robust coplanar double mold structure, TD851 series provide the most stable isolation feature.

#### **Features**

- High isolation 5000 VRMS
- DC input with transistor output
- Operating temperature range 55 °C to 110 °C
- REACH compliance
- Halogen free
- MSL class 1
- Regulatory Approvals
  - UL UL1577
  - VDE EN60747-5-5(VDE0884-5)
  - CQC GB4943.1, GB8898
  - cUL- CSA Component Acceptance
     Service Notice No. 5A

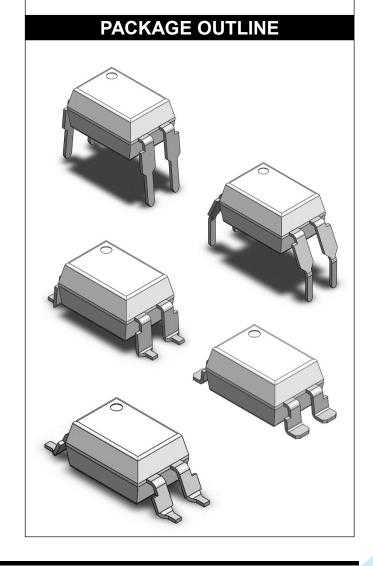
#### **Applications**

- Switch mode power supplies
- Programmable controllers
- Household appliances
- Office equipment



#### PIN DEFINITION

- 1. Anode
- 2. Cathode
- 3. Emitter
- 4. Collector





ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	VALUE	UNIT	NOTE		
INPUT						
Forward Current	I <sub>F</sub>	60	mA			
Peak Forward Current	I <sub>FP</sub>	1	Α	1		
Reverse Voltage	V <sub>R</sub>	6	V			
Input Power Dissipation	Pı	100	mW			
OUTPUT						
Collector - Emitter Voltage	V <sub>CEO</sub>	350	V			
Emitter - Collector Voltage	V <sub>ECO</sub>	7	V			
Collector Current	Ic	50	mA			
Output Power Dissipation	Po	150	mW			
COMMON						
Total Power Dissipation	Ptot	200	mW			
Isolation Voltage	Viso	5000	Vrms	2		
Operating Temperature	Topr	-55~110	°C			
Storage Temperature	Tstg	-55~150	°C			
Soldering Temperature	Tsol	260	°C			

Note 1. 100µs pulse, 100Hz frequency

Note 2. AC For 1 Minute, R.H. =  $40 \sim 60\%$ 



	ELECT	RICAL OF	PTICA	L CHA	ARAC	TER	ISTICS at Ta=25°C	
PARAME	TER	SYMBOL	MIN	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
INPUT								
Forward V	oltage	V <sub>F</sub>	-	1.24	1.4	V	IF=10mA	
Reverse C	Reverse Current		-	-	10	μA	VR=6V	
Input Capa	Input Capacitance		-	10	-	pF	V=0, f=1kHz	
OUTPUT								
Collector Dar	k Current	I <sub>CEO</sub>	-	-	100	nA	VCE=200V, IF=0	
Collector-E Breakdown		BV <sub>CEO</sub>	350	_	-	V	IC=0.1mA, IF=0	
Emitter-Co Breakdown		BV <sub>ECO</sub>	7	-	-	V	IE=0.1mA, IF=0	
TRANSFER CHARACTERISTICS								
Current Transfer Ratio	TD851	CTR	50	-	600	%	IF=5mA, VCE=5V	
Collector-E Saturation \		V <sub>CE(sat)</sub>	-	0.055	0.4	V	IF=20mA, IC=1mA	
Isolation Re	sistance	R <sub>ISO</sub>	10^12	10^14	-	Ω	DC500V, 40 ~ 60% R.H.	
Floating Cap	acitance	C <sub>IO</sub>	-	0.6	1	pF	V=0, f=1MHz	
Response Tir	me (Rise)	tr	-	2	18	μs	VCE=2V, IC=2mA	3
Response Ti	me (Fall)	tf	-	4	18	8 μs RL=100Ω 3		3
Cut-off Free	quency	fc	-	80	-	kHz	VCE=2V, IC=2mA RL=100Ω,-3dB	

Note 3. Fig.12&13

Note 4. Fig.14



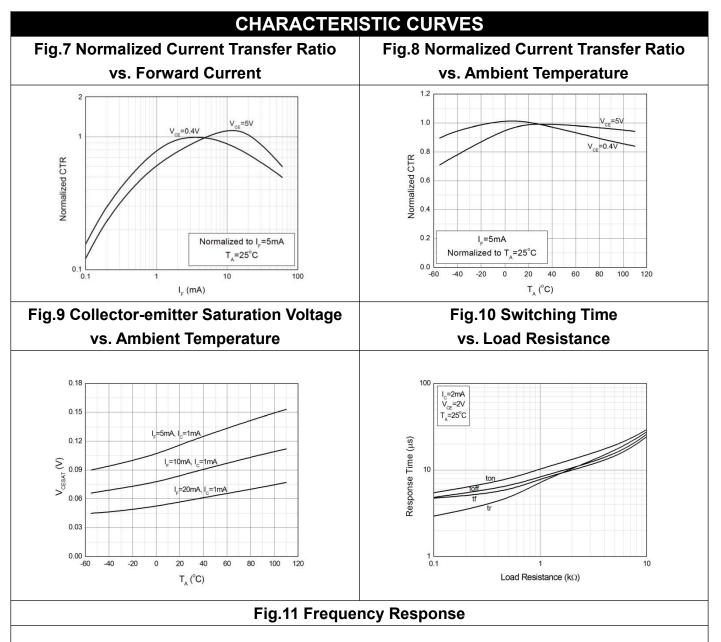
#### **CHARACTERISTIC CURVES Fig.2 Collector Power Dissipation** Fig.1 Forward Current vs. Ambient Temperature vs. Ambient Temperature 120 60 100 $P_{c}$ (mW) 20 80 60 -20 80 100 T<sub>A</sub> (°C) T<sub>A</sub> (°C) Fig.4 Collector Dark Current Fig.3 Forward Current vs. Forward Voltage vs. Ambient Temperature 10000 1000 V\_=200V I<sub>F</sub> (mA) 0°C 0.9 1.0 1.5 1.6 1.1 1.2 $V_{F}(V)$ T<sub>A</sub> (°C) **Fig.5 Collector Current Fig.6 Collector Current** vs. Collector-emitter Voltage vs. Collector-emitter Voltage T<sub>A</sub>=25°C T<sub>A</sub>=25°C I<sub>=</sub>=10mA PC=150mW ا<sub>د</sub> (mA) L=5mA I\_=10mA

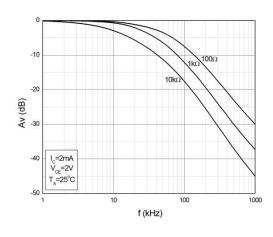
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 $V_{CE}(V)$ 

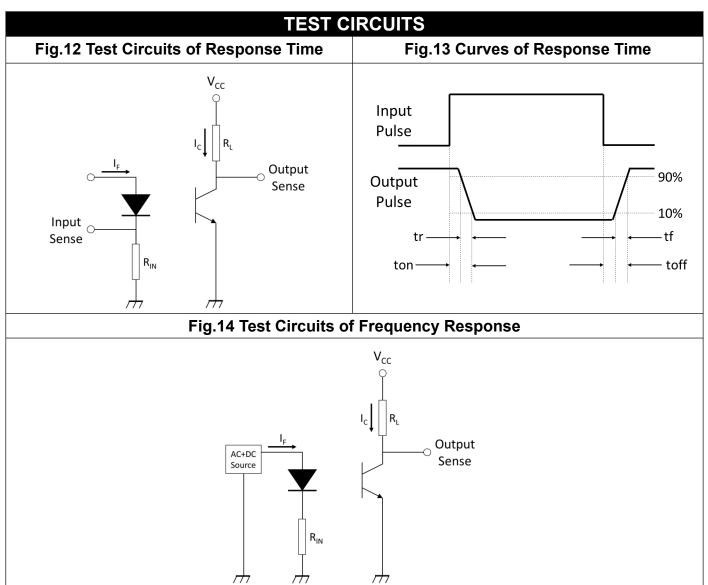
I\_=5mA













## PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated) Standard DIP - Through Hole (DIP Type) 6.50±0.20 4.58±0.20 7.62±0.30 1.30±0.10 3.50±0.20 4.50±0.30 Тур.2.80 Typ.0.50 Typ.0.25 5°~15° Typ.2.54 7.62~9.50 Gullwing (400mil) Lead Forming – Through Hole (M Type) 6.50±0.20 4.58±0.20 7.62±0.30 1.30±0.10 3.50±0.20

Typ.0.50

Typ.0.25

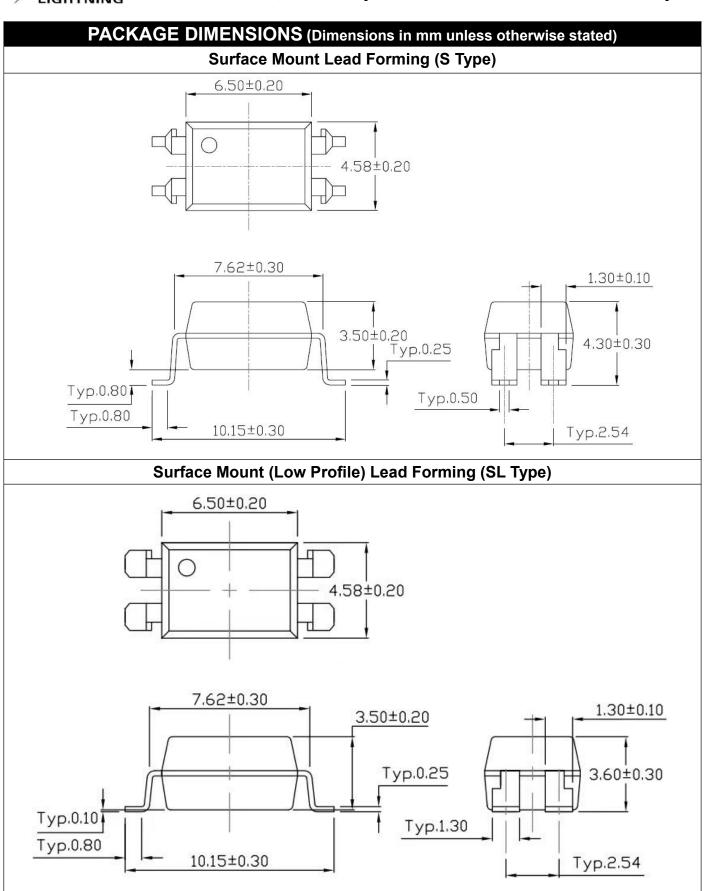
10.16±0.30

4.58±0.30

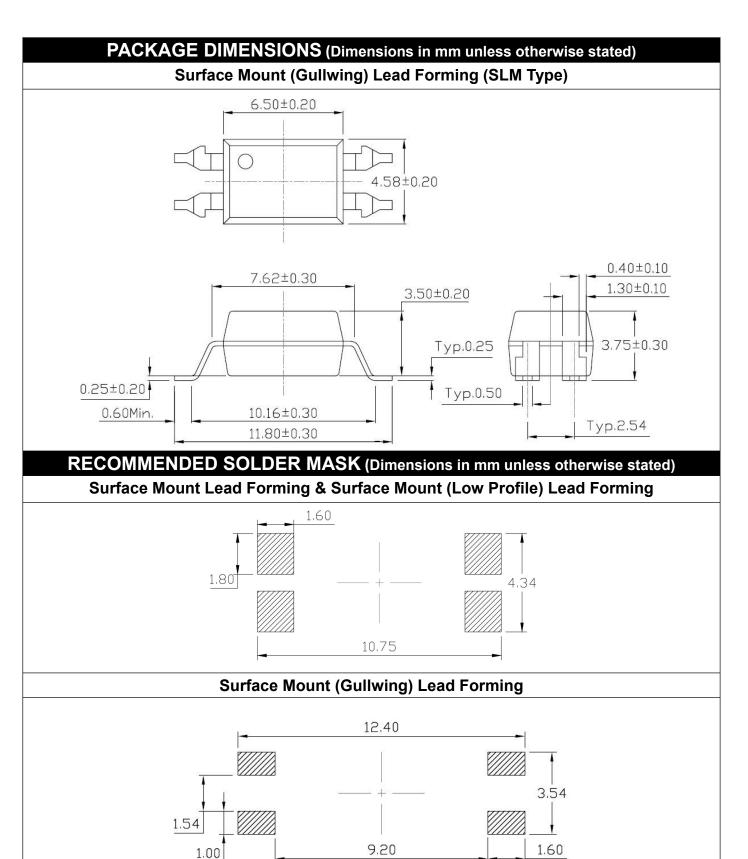
Typ.2.20

Typ.2.54

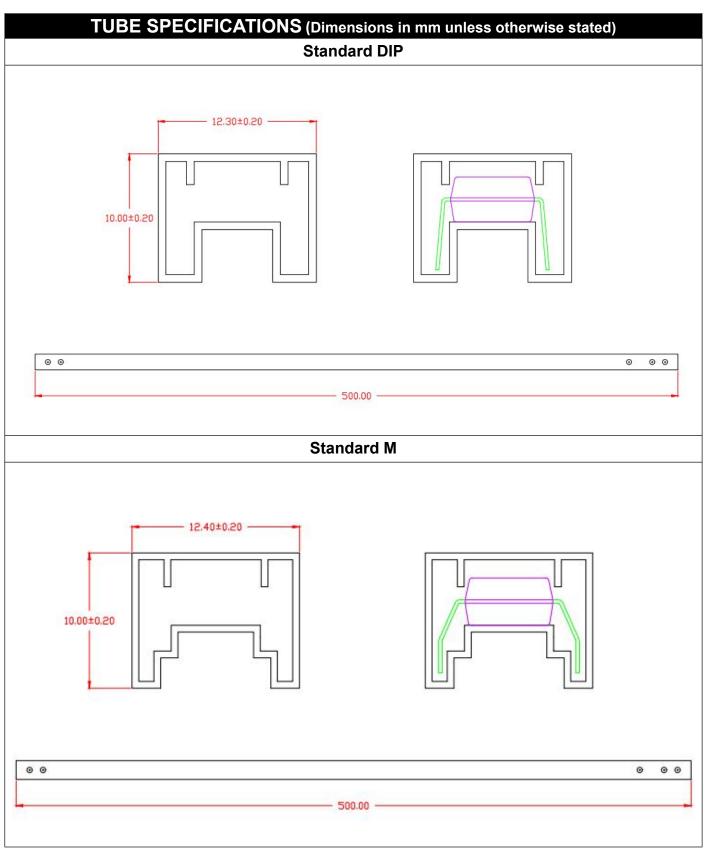




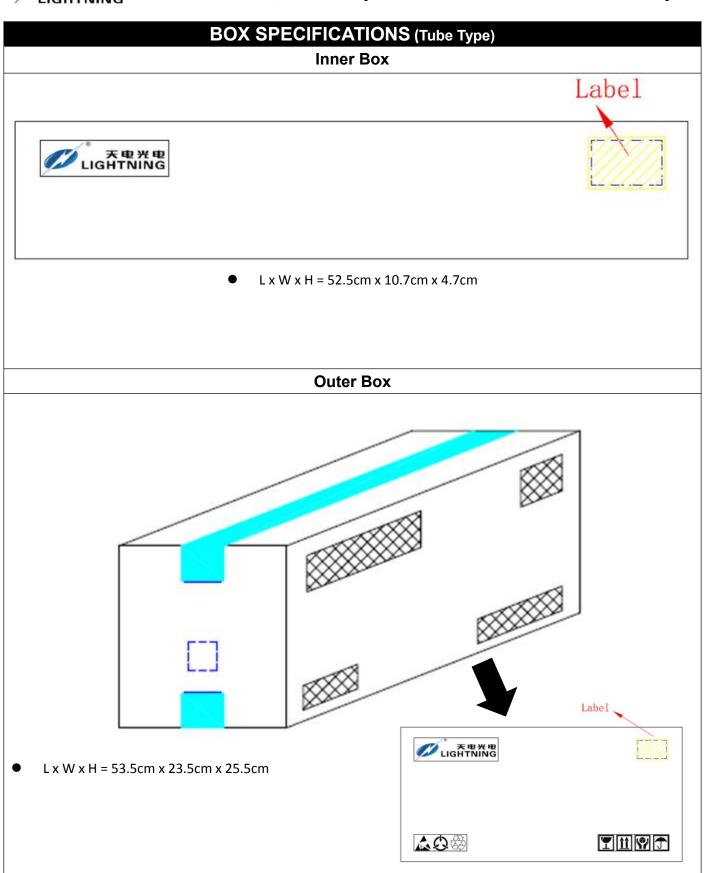




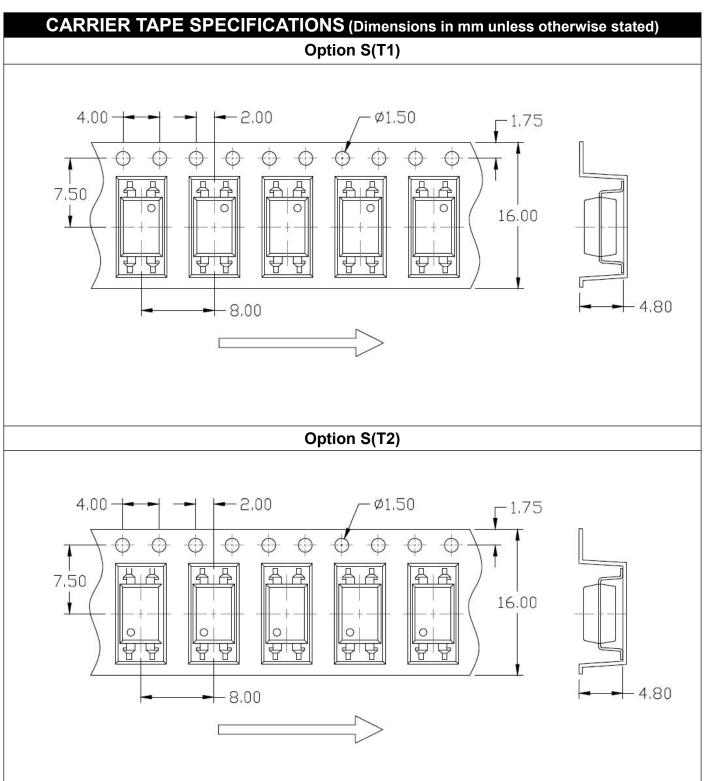




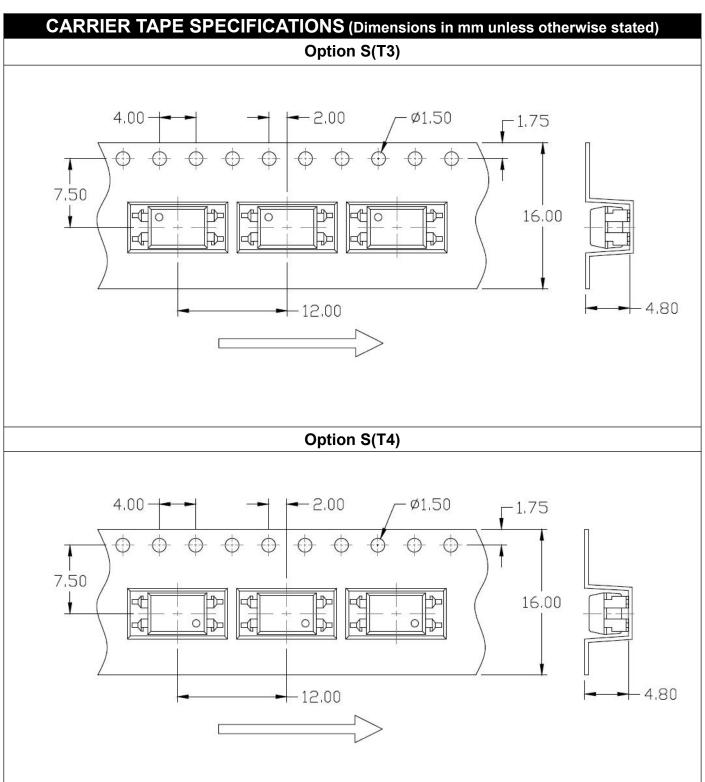




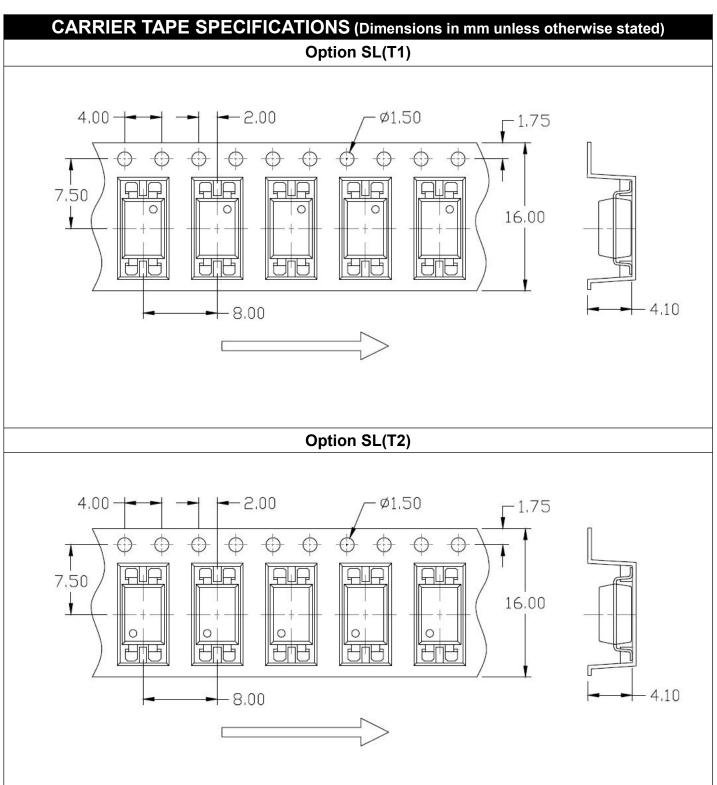




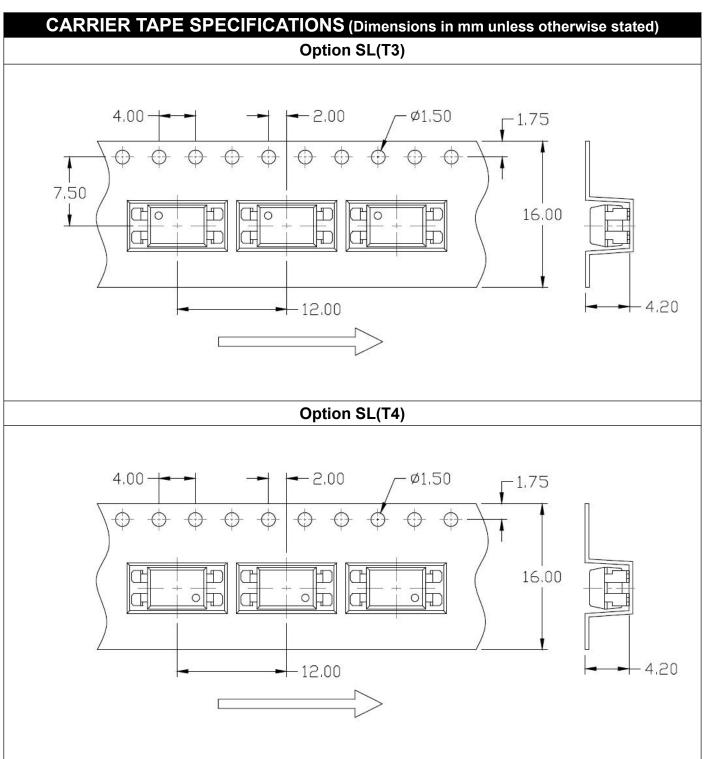




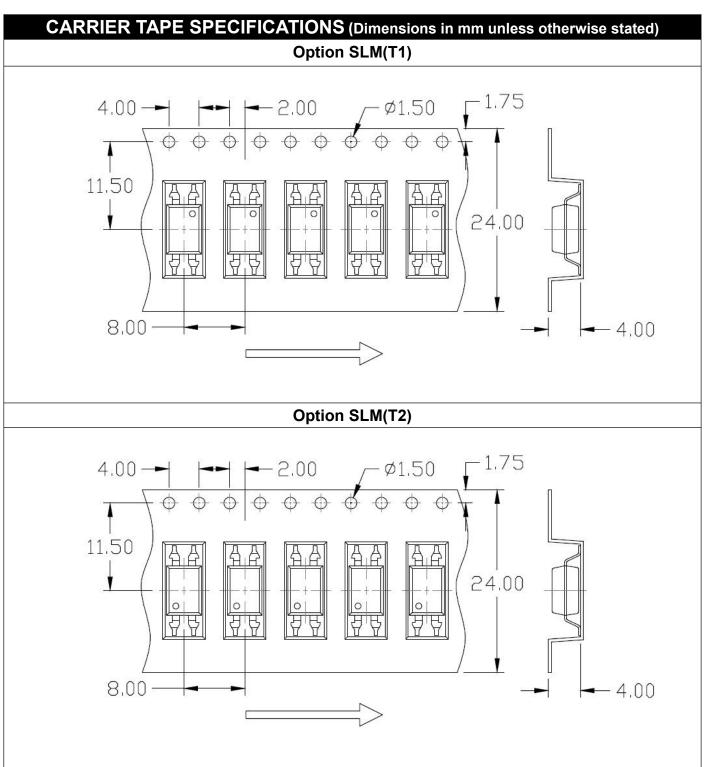




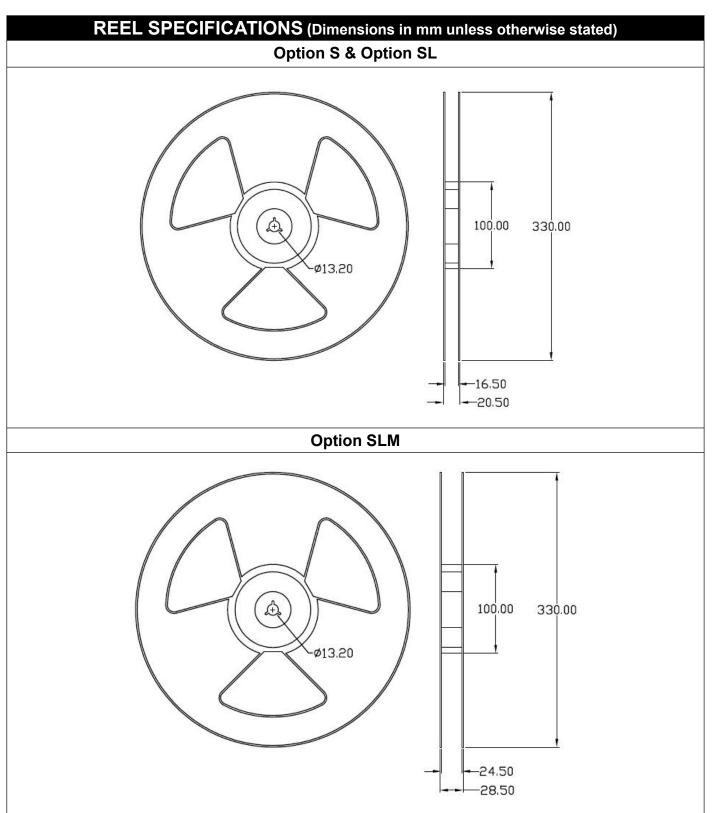




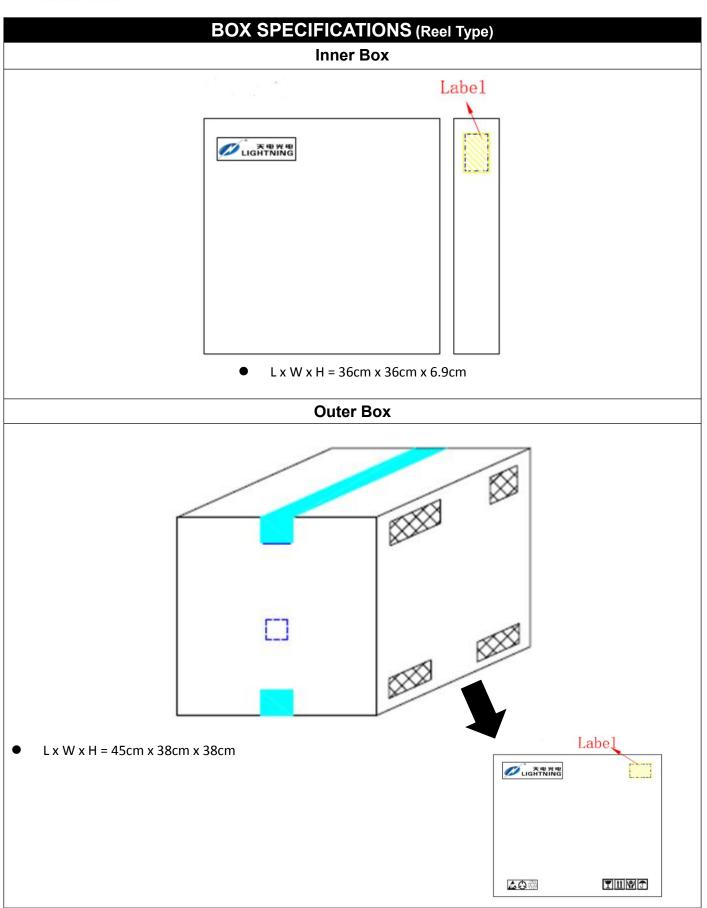














#### ORDERING AND MARKING INFORMATION

#### MARKING INFORMATION



TD : Company Abbr.

851 : Part Number

X : CTR Rank

V : VDE Option Y : Fiscal Year

A : Manufacturing Code

WW : Work Week

#### ORDERING INFORMATION

#### TD851(Y)(Z)-GV

TD - Company Abbr.

851 - Part Number

Y – Lead Form Option (M/S/SL/SLM/None)

Z – Tape and Reel Option (T1/T2/T3/T4)

G - Green

V – VDE Option (V or None)

#### LABEL INFORMATION



#### **Packing Quantity**

Packing Quantity				
Option	Quantity	Quantity – Inner box	Quantity – Outer box	
None	100 Units/Tube	32 Tubes/Inner box	10 Inner box/Outer box = 32k Units	
М	100 Units/Tube	32 Tubes/Inner box	10 Inner box/Outer box = 32k Units	
S(T1)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units	
S(T2)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units	
S(T3)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units	
S(T4)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units	
SL(T1)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units	
SL(T2)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units	
SL(T3)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units	
SL(T4)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units	
SLM(T1)	1500 Units/Reel	2 Reels/Inner box	5 Inner box/Outer box = 15k Units	
SLM(T2)	1500 Units/Reel	2 Reels/Inner box	5 Inner box/Outer box = 15k Units	

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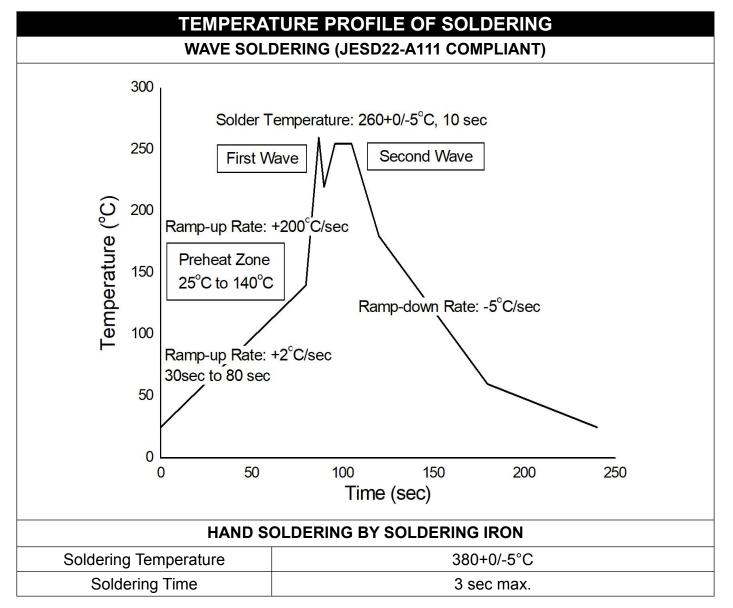


### DIP4, DC Input, Photo Transistor Coupler

### **REFLOW INFORMATION REFLOW PROFILE** Supplier T<sub>p</sub> ≥ T<sub>c</sub> User $T_p \le T_c$ T<sub>C</sub> -5°C Supplier tp -T<sub>c</sub> -5°C Temperature 📑 Max. Ramp Up Rate = 3°C/s Max. Ramp Down Rate = 6°C/s $T_L$ T<sub>smax</sub> Preheat Area T<sub>smin</sub> 25 Time 25°C to Peak -Time ⇒

Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	100	150°C
Temperature Max. (Tsmax)	150	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds	60-120 seconds
Ramp-up Rate (tL to tP)	3°C/second max.	3°C/second max.
Liquidous Temperature (TL)	183°C	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time (tP) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.





- One time soldering is recommended for all soldering method.
- Do not solder more than three times for IR reflow soldering.



#### **DISCLAIMER**

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- The characteristic curves shown in this datasheet are representing typical performance which are not guaranteed.
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- Please contact LIGHTNING sales agent for special application request.
- Immerge unit's body in solder paste is not recommended.
- Parameters provided in datasheets may vary in different applications and performance may vary
  over time. All operating parameters, including typical parameters, must be validated in each
  customer application by the customer's technical experts. Product specifications do not expand or
  otherwise modify LIGHTNING's terms and conditions of purchase, including but not limited to the
  warranty expressed therein.
- Discoloration might be occurred on the package surface after soldering, reflow or long-time use. It neither impacts the performance nor reliability.